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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	25MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	36
Program Memory Size	8KB (4K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	4.2V ~ 5.5V
Data Converters	A/D 13x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Through Hole
Package / Case	40-DIP (0.600", 15.24mm)
Supplier Device Package	40-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f4321-e-p

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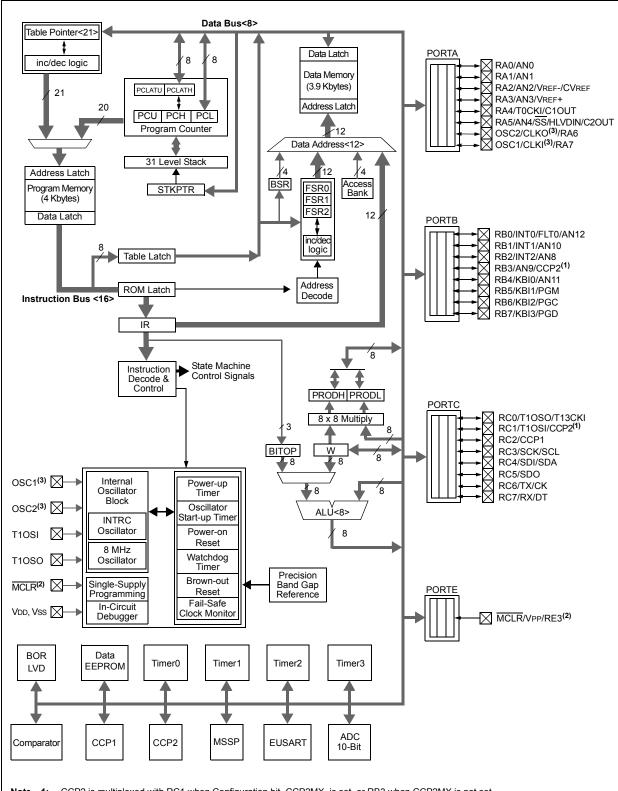


FIGURE 1-1: PIC18F2221/2321 (28-PIN) BLOCK DIAGRAM

Note 1: CCP2 is multiplexed with RC1 when Configuration bit, CCP2MX, is set, or RB3 when CCP2MX is not set.

2: RE3 is only available when $\overline{\text{MCLR}}$ functionality is disabled.

3: OSC1/CLKI and OSC2/CLKO are only available in select oscillator modes and when these pins are not being used as digital I/O. Refer to Section 3.0 "Oscillator Configurations" for additional information.

4.5.4 EXIT WITHOUT AN OSCILLATOR START-UP DELAY

Certain exits from power-managed modes do not invoke the OST at all. There are two cases:

- PRI_IDLE mode, where the primary clock source is not stopped; and
- the primary clock source is not any of the LP, XT, HS or HSPLL modes.

In these instances, the primary clock source either does not require an oscillator start-up delay since it is already running (PRI_IDLE), or normally does not require an oscillator start-up delay (RC, EC and INTIO Oscillator modes). However, a fixed delay of interval TCSD following the wake event is still required when leaving Sleep and Idle modes to allow the CPU to prepare for execution. Instruction execution resumes on the first clock cycle following this delay.

TABLE 4-2:EXIT DELAY ON WAKE-UP BY RESET FROM SLEEP MODE OR ANY IDLE MODE
(BY CLOCK SOURCES)

Clock Source before Wake-up	Clock Source after Wake-up	Exit Delay	Clock Ready Status Bit (OSCCON)
	LP, XT, HS		
Primary Device Clock	HSPLL	TCSD ⁽¹⁾	OSTS
(PRI_IDLE mode)	EC, RC		
	INTOSC ⁽²⁾		IOFS
	LP, XT, HS	Tost ⁽³⁾	
11050	HSPLL	Tost + t _{rc} ⁽³⁾	OSTS
T1OSC	EC, RC	TCSD ⁽¹⁾	
	INTOSC ⁽²⁾	TIOBST ⁽⁴⁾	IOFS
	LP, XT, HS	Tost ⁽³⁾	
INTOSC ⁽³⁾	HSPLL	Tost + t _{rc} ⁽³⁾	OSTS
	EC, RC	Tcsd ⁽¹⁾	
	INTOSC ⁽²⁾	None	IOFS
	LP, XT, HS	Tost ⁽³⁾	
None	HSPLL	Tost + t _{rc} ⁽³⁾	OSTS
(Sleep mode)	EC, RC	TCSD ⁽¹⁾	
	INTOSC ⁽²⁾	TIOBST ⁽⁴⁾	IOFS

Note 1: TCSD (parameter 38) is a required delay when waking from Sleep and all Idle modes and runs concurrently with any other required delays (see **Section 4.4 "Idle Modes**"). On Reset, INTOSC defaults to 1 MHz.

2: Includes both the INTOSC 8 MHz source and postscaler derived frequencies.

3: TOST is the Oscillator Start-up Timer (parameter 32). t_{rc} is the PLL Lock-out Timer (parameter F12); it is also designated as TPLL.

4: Execution continues during TIOBST (parameter 39), the INTOSC stabilization period.

5.5 Device Reset Timers

PIC18F2221/2321/4221/4321 family devices incorporate three separate on-chip timers that help regulate the Power-on Reset process. Their main function is to ensure that the device clock is stable before code is executed. These timers are:

- Power-up Timer (PWRT)
- Oscillator Start-up Timer (OST)
- PLL Lock Time-out

5.5.1 POWER-UP TIMER (PWRT)

The Power-up Timer (PWRT) of the PIC18F2221/ 2321/4221/4321 family devices is an 11-bit counter which uses the INTRC source as the clock input. This yields an approximate time interval of 2048 x 32 μ s = 65.6 ms. While the PWRT is counting, the device is held in Reset.

The power-up time delay depends on the INTRC clock and will vary from chip to chip due to temperature and process variation. See DC parameter 33 for details.

The PWRT is enabled by clearing the PWRTEN Configuration bit.

5.5.2 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-up Timer (OST) provides a 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over (parameter 33). This ensures that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP, HS and HSPLL modes and only on Power-on Reset, or on exit from most power-managed modes.

5.5.3 PLL LOCK TIME-OUT

With the PLL enabled in HSPLL mode, the time-out sequence following a Power-on Reset is slightly different from other oscillator modes. A separate timer is used to provide a fixed time-out that is sufficient for the PLL to lock to the main oscillator frequency. This PLL lock time-out (TPLL) is typically 2 ms and follows the oscillator start-up time-out.

5.5.4 TIME-OUT SEQUENCE

On power-up, the time-out sequence is as follows:

- 1. After the POR pulse has cleared, PWRT time-out is invoked (if enabled).
- 2. Then, the OST is activated.

The total time-out will vary based on oscillator configuration and the status of the PWRT. Figure 5-3, Figure 5-4, Figure 5-5, Figure 5-6 and Figure 5-7 all depict time-out sequences on power-up, with the Power-up Timer enabled and the device operating in HS Oscillator mode. Figures 5-3 through 5-6 also apply to devices operating in XT or LP modes. For devices in RC mode and with the PWRT disabled, there will be no time-out at all.

Since the time-outs occur from the POR pulse, if MCLR is kept low long enough, all time-outs will expire. Bringing MCLR high will begin execution immediately (Figure 5-5). This is useful for testing purposes or to synchronize more than one PIC18FXXXX device operating in parallel.

Oscillator	Power-up ⁽²⁾ and	Exit from		
Configuration	PWRTEN = 0	PWRTEN = 1	Power-Managed Mode	
HSPLL	66 ms ⁽¹⁾ + 1024 Tosc + 2 ms ⁽²⁾	1024 Tosc + 2 ms ⁽²⁾	1024 Tosc + 2 ms ⁽²⁾	
HS, XT, LP	66 ms ⁽¹⁾ + 1024 Tosc	1024 Tosc	1024 Tosc	
EC, ECIO	66 ms ⁽¹⁾	_	—	
RC, RCIO	66 ms ⁽¹⁾	_	—	
INTIO1, INTIO2	66 ms ⁽¹⁾	—	—	

TABLE 5-2:TIME-OUT IN VARIOUS SITUATIONS

Note 1: 66 ms (65.5 ms) is the nominal Power-up Timer (PWRT) delay.

2: 2 ms is the nominal time required for the PLL to lock.

6.0 MEMORY ORGANIZATION

There are three types of memory in PIC18 Enhanced microcontroller devices:

- Program Memory
- Data RAM
- Data EEPROM

As Harvard architecture devices, the data and program memories use separate busses; this allows for concurrent access of the two memory spaces. The data EEPROM, for practical purposes, can be regarded as a peripheral device, since it is addressed and accessed through a set of control registers.

Additional detailed information on the operation of the Flash program memory is provided in Section 7.0 "Flash Program Memory". Data EEPROM is discussed separately in Section 8.0 "Data EEPROM Memory".

6.1 Program Memory Organization

PIC18 microcontrollers implement a 21-bit program counter, which is capable of addressing a 2-Mbyte program memory space. Accessing a location between the upper boundary of the physically implemented memory and the 2-Mbyte address will return all '0's (a NOP instruction).

The PIC18F2221 and PIC18F4221 each have 4 Kbytes of Flash memory and can store up to 2048 single-word instructions. The PIC18F2321 and PIC18F4321 each have 8 Kbytes of Flash memory and can store up to 4096 single-word instructions.

PIC18 devices have two interrupt vectors. The Reset vector address is at 0000h and the interrupt vector addresses are at 0008h and 0018h.

The program memory maps for PIC18F2221/4221 and PIC18F2321/4321 devices are shown in Figure 6-1.

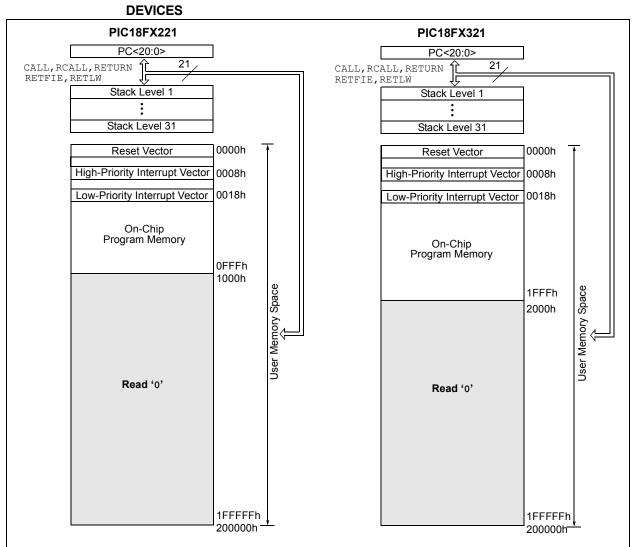


FIGURE 6-1: PROGRAM MEMORY MAP AND STACK FOR PIC18F2221/2321/4221/4321 FAMILY

6.1.1 PROGRAM COUNTER

The Program Counter (PC) specifies the address of the instruction to fetch for execution. The PC is 21 bits wide and is contained in three separate 8-bit registers. The low byte, known as the PCL register, is both readable and writable. The high byte, or PCH register, contains the PC<15:8> bits; it is not directly readable or writable. Updates to the PCH register are performed through the PCLATH register. The upper byte is called PCU. This register contains the PC<20:16> bits; it is also not directly readable or writable. Updates to the PCH register. Updates to the PCU register are performed through the PCLATH register contains the PC<20:16> bits; it is also not directly readable or writable. Updates to the PCU register are performed through the PCLATU register.

The contents of PCLATH and PCLATU are transferred to the program counter by any operation that writes PCL. Similarly, the upper two bytes of the program counter are transferred to PCLATH and PCLATU by an operation that reads PCL. This is useful for computed offsets to the PC (see **Section 6.1.4.1 "Computed GOTO"**).

The PC addresses bytes in the program memory. To prevent the PC from becoming misaligned with word instructions, the Least Significant bit of PCL is fixed to a value of '0'. The PC increments by 2 to address sequential instructions in the program memory.

The CALL, RCALL, GOTO and program branch instructions write to the program counter directly. For these instructions, the contents of PCLATH and PCLATU are not transferred to the program counter.

6.1.2 RETURN ADDRESS STACK

The return address stack allows any combination of up to 31 program calls and interrupts to occur. The PC is pushed onto the stack when a CALL or RCALL instruction is executed or an interrupt is Acknowledged. The PC value is pulled off the stack on a RETURN, RETLW or a RETFIE instruction. PCLATU and PCLATH are not affected by any of the RETURN or CALL instructions.

The stack operates as a 31-word by 21-bit RAM and a 5-bit Stack Pointer, STKPTR. The stack space is not part of either program or data space. The Stack Pointer is readable and writable and the address on the top of the stack is readable and writable through the Top-of-Stack Special Function Registers. Data can also be pushed to, or popped from the stack, using these registers.

A CALL type instruction causes a push onto the stack; the Stack Pointer is first incremented and the location pointed to by the Stack Pointer is written with the contents of the PC (already pointing to the instruction following the CALL). A RETURN type instruction causes a pop from the stack; the contents of the location pointed to by the STKPTR are transferred to the PC and then the Stack Pointer is decremented.

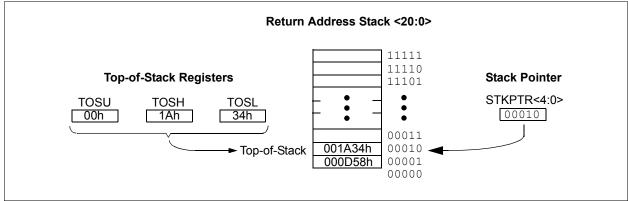
The Stack Pointer is initialized to '00000' after all Resets. There is no RAM associated with the location corresponding to a Stack Pointer value of '00000'; this is only a Reset value. Status bits indicate if the stack is full or has overflowed or has underflowed.

6.1.2.1 Top-of-Stack Access

Only the top of the return address stack (TOS) is readable and writable. A set of three registers, TOSU:TOSH:TOSL, hold the contents of the stack location pointed to by the STKPTR register (Figure 6-2). This allows users to implement a software stack if necessary. After a CALL, RCALL or interrupt, the software can read the pushed value by reading the TOSU:TOSH:TOSL registers. These values can be placed on a user-defined software stack. At return time, the software can return these values to TOSU:TOSH:TOSL and do a return.

The user must disable the global interrupt enable bits while accessing the stack to prevent inadvertent stack corruption.

FIGURE 6-2: RETURN ADDRESS STACK AND ASSOCIATED REGISTERS



8.0 DATA EEPROM MEMORY

The data EEPROM is a nonvolatile memory array, separate from the data RAM and program memory, that is used for long-term storage of program data. It is not directly mapped in either the register file or program memory space but is indirectly addressed through the Special Function Registers (SFRs). The EEPROM is readable and writable during normal operation over the entire VDD range.

Four SFRs are used to read and write to the data EEPROM as well as the program memory. They are:

- EECON1
- EECON2
- EEDATA
- EEADR

The data EEPROM allows byte read and write. When interfacing to the data memory block, EEDATA holds the 8-bit data for read/write and the EEADR register holds the address of the EEPROM location being accessed.

The EEPROM data memory is rated for high erase/write cycle endurance. A byte write automatically erases the location and writes the new data (erase-before-write). The write time is controlled by an on-chip timer. It will vary with voltage and temperature as well as from chip to chip. Please refer to parameter D122 (Table 27-1 in **Section 27.0 "Electrical Characteristics"**) for exact limits.

8.1 EECON1 and EECON2 Registers

Access to the data EEPROM is controlled by two registers: EECON1 and EECON2. These are the same registers which control access to the program memory and are used in a similar manner for the data EEPROM.

The EECON1 register (Register 8-1) is the control register for data and program memory access. Control bit EEPGD determines if the access will be to program or data EEPROM memory. When clear, operations will access the data EEPROM memory. When set, program memory is accessed.

Control bit CFGS determines if the access will be to the Configuration registers or to program memory/data EEPROM memory. When set, subsequent operations access Configuration registers. When CFGS is clear, the EEPGD bit selects either program Flash or data EEPROM memory.

The WREN bit, when set, will allow a write operation. On power-up, the WREN bit is clear. The WRERR bit is set in hardware when the WREN bit is set and cleared when the internal programming timer expires and the write operation is complete.

Note:	During normal operation, the WRERR bit									
	is read as '1'. This can indicate that a write									
	operation was prematurely terminated by									
	a Reset, or a write operation was									
	attempted improperly.									

The WR control bit initiates write operations. The bit cannot be cleared, only set, in software; it is cleared in hardware at the completion of the write operation.

Note:	The EEIF interrupt flag bit (PIR2<4>) is set								
	when the write is complete. It must be								
	cleared in software.								

Control bits, RD and WR, start read and erase/write operations, respectively. These bits are set by firmware and cleared by hardware at the completion of the operation.

The RD bit cannot be set when accessing program memory (EEPGD = 1). Program memory is read using table read instructions. See **Section 7.1 "Table Reads** and **Table Writes"** regarding table reads.

The EECON2 register is not a physical register. It is used exclusively in the memory write and erase sequences. Reading EECON2 will read all '0's.

11.5 PORTE, TRISE and LATE Registers

Depending on the particular PIC18F2221/2321/4221/ 4321 family device selected, PORTE is implemented in two different ways.

For 40/44-pin devices, PORTE is a 4-bit wide port. Three pins (RE0/RD/AN5, RE1/WR/AN6 and RE2/CS/ AN7) are individually configurable as inputs or outputs. These pins have Schmitt Trigger input buffers. When selected as analog inputs, these pins will read as '0'.

The corresponding Data Direction register is TRISE. Setting a TRISE bit (= 1) will make the corresponding PORTE pin an input (i.e., put the corresponding output driver in a High-Impedance mode). Clearing a TRISE bit (= 0) will make the corresponding PORTE pin an output (i.e., put the contents of the output latch on the selected pin).

TRISE controls the direction of the RE pins, even when they are being used as analog inputs. The user must make sure to keep the pins configured as inputs when using them as analog inputs.

Note:	On	а	Power-on	Reset,	RE<2:0>	are
	con	figu	red as anal	og input	5.	

The upper four bits of the TRISE register also control the operation of the Parallel Slave Port. Their operation is explained in Register 11-1.

The Data Latch register (LATE) is also memory mapped. Read-modify-write operations on the LATE register, read and write the latched output value for PORTE.

The fourth pin of PORTE ($\overline{\text{MCLR}}/\text{VPP}/\text{RE3}$) is an input only pin. Its operation is controlled by the MCLRE Configuration bit. When selected as a port pin (MCLRE = 0), it functions as a digital input only pin; as such, it does not have TRIS or LAT bits associated with its operation. Otherwise, it functions as the device's Master Clear input. In either configuration, RE3 also functions as the programming voltage input during programming.

Note:	On a Power-on Reset, RE3 is enabled as									
	a digital input only if Master Clear									
	functionality is disabled.									

EXAMPLE 11-5: INITIALIZING PORTE

	-		
CLRF	PORTE		Initialize PORTE by clearing output
		;	data latches
CLRF	LATE	;	Alternate method
		;	to clear output
		;	data latches
MOVLW	OFh	;	Configure A/D
MOVWF	ADCON1	;	for digital inputs
MOVLW	03h	;	Value used to
		;	initialize data
		;	direction
MOVWF	TRISE	;	Set RE<0> as inputs
		;	RE<1> as outputs
		;	RE<2> as inputs

11.5.1 PORTE IN 28-PIN DEVICES

For 28-pin devices, PORTE is only available when Master Clear functionality is disabled (MCLRE = 0). In these cases, PORTE is a single bit, input only port comprised of RE3 only. The pin operates as previously described.

17.0 ENHANCED CAPTURE/ COMPARE/PWM (ECCP) MODULE

Note:	The ECCP module is implemented only in
	40/44-pin devices.

In PIC18F4221/4321 devices, CCP1 is implemented as a standard CCP module with Enhanced PWM capabilities. These include the provision for 2 or 4 output channels, user-selectable polarity, dead-band control and automatic shutdown and restart. The Enhanced features are discussed in detail in **Section 17.4 "Enhanced PWM Mode"**. Capture, Compare and single-output PWM functions of the ECCP module are the same as described for the standard CCP module.

The control register for the Enhanced CCP module is shown in Register 17-1. It differs from the CCPxCON registers in PIC18F2221/2321 devices in that the two Most Significant bits are implemented to control PWM functionality.

REGISTER 17-1: CCP1CON REGISTER (ECCP1 MODULE, 40/44-PIN DEVICES)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
P1M1	P1M0	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0
bit 7							bit 0

bit 7-6 P1M<1:0>: Enhanced PWM Output Configuration bits

If CCP1M<3:2> = 00, 01, 10:

xx = P1A assigned as Capture/Compare input/output; P1B, P1C, P1D assigned as port pins
If CCP1M<3:2> = 11:

- 00 = Single output: P1A modulated; P1B, P1C, P1D assigned as port pins
- 01 = Full-bridge output forward: P1D modulated; P1A active; P1B, P1C inactive
- 10 = Half-bridge output: P1A, P1B modulated with dead-band control; P1C, P1D assigned as port pins
- 11 = Full-bridge output reverse: P1B modulated; P1C active; P1A, P1D inactive
- bit 5-4 **DC1B<1:0>**: PWM Duty Cycle bit 1 and bit 0

Capture mode:

Unused.

Compare mode:

Unused.

PWM mode:

These bits are the two LSbs of the 10-bit PWM duty cycle. The eight MSbs of the duty cycle are found in CCPR1L.

bit 3-0 **CCP1M<3:0>**: Enhanced CCP Mode Select bits

- 0000 = Capture/Compare/PWM off (resets ECCP module)
- 0001 = Reserved
- 0010 = Compare mode, toggle output on match
- 0011 = Capture mode
- 0100 = Capture mode, every falling edge
- 0101 = Capture mode, every rising edge
- 0110 = Capture mode, every 4th rising edge
- 0111 = Capture mode, every 16th rising edge
- 1000 = Compare mode, initialize CCP1 pin low, set output on compare match (set CCP1IF)
- 1001 = Compare mode, initialize CCP1 pin high, clear output on compare match (set CCP1IF)
- 1010 = Compare mode, generate software interrupt only, CCP1 pin reverts to I/O state
- 1011 = Compare mode, trigger special event (ECCP resets TMR1 or TMR3, sets CC1IF bit)
- 1100 = PWM mode; P1A, P1C active-high; P1B, P1D active-high
- 1101 = PWM mode; P1A, P1C active-high; P1B, P1D active-low
- 1110 = PWM mode; P1A, P1C active-low; P1B, P1D active-high
- 1111 = PWM mode; P1A, P1C active-low; P1B, P1D active-low

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

18.4.2 OPERATION

The MSSP module functions are enabled by setting MSSP Enable bit, SSPEN (SSPCON1<5>).

The SSPCON1 register allows control of the I^2C operation. Four mode selection bits (SSPCON1<3:0>) allow one of the following I^2C modes to be selected:

- I²C Master mode clock
- I²C Slave mode (7-bit address)
- I²C Slave mode (10-bit address)
- I²C Slave mode (7-bit address) with Start and Stop bit interrupts enabled
- I²C Slave mode (10-bit address) with Start and Stop bit interrupts enabled
- I²C Firmware Controlled Master mode, slave is Idle

Selection of any I²C mode with the SSPEN bit set, forces the SCL and SDA pins to be open-drain, provided these pins are programmed to inputs by setting the appropriate TRISC bits. To ensure proper operation of the module, pull-up resistors must be provided externally to the SCL and SDA pins.

18.4.3 SLAVE MODE

In Slave mode, the SCL and SDA pins must be configured as inputs (TRISC<4:3> set). The MSSP module will override the input state with the output data when required (slave-transmitter).

The I²C Slave mode hardware will always generate an interrupt on an address match. Address masking will allow the hardware to generate an interrupt for more than one address (up to 31 in 7-Bit Addressing mode and up to 63 in 10-Bit Addressing mode). Through the mode select bits, the user can also choose to interrupt on Start and Stop bits

When an address is matched, or the data transfer after an address match is received, the hardware automatically will generate the Acknowledge (\overrightarrow{ACK}) pulse and load the SSPBUF register with the received value currently in the SSPSR register.

Any combination of the following conditions will cause the MSSP module not to give this ACK pulse:

- The Buffer Full bit, BF (SSPSTAT<0>), was set before the transfer was received.
- The overflow bit, SSPOV (SSPCON1<6>), was set before the transfer was received.

In this case, the SSPSR register value is not loaded into the SSPBUF, but bit SSPIF (PIR1<3>) is set. The BF bit is cleared by reading the SSPBUF register, while bit SSPOV is cleared through software.

The SCL clock input must have a minimum high and low for proper operation. The high and low times of the I^2C specification, as well as the requirement of the MSSP module, are shown in timing parameter 100 and parameter 101.

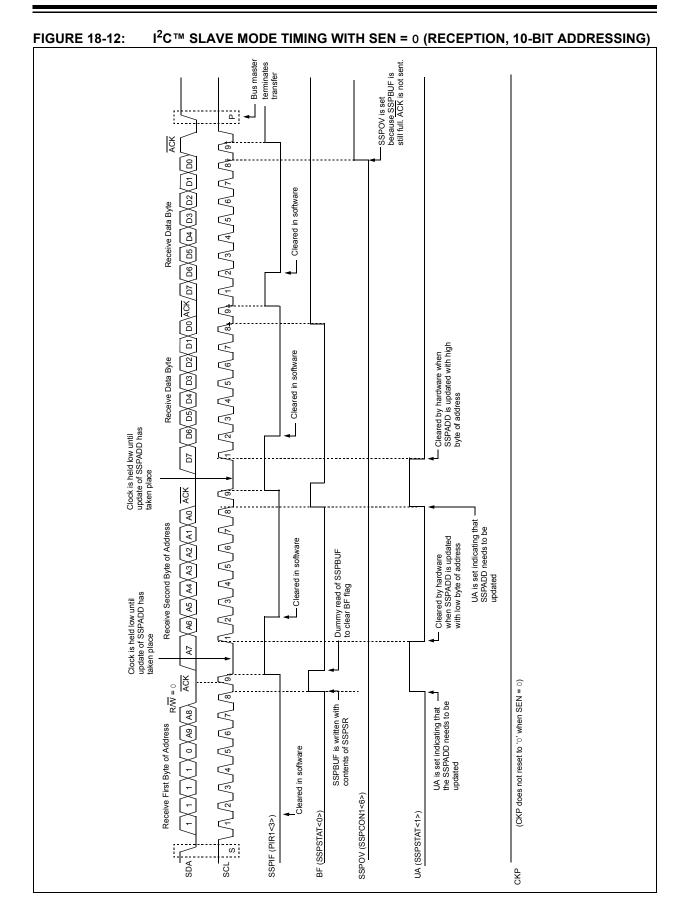
18.4.3.1 Addressing

Once the MSSP module has been enabled, it waits for a Start condition to occur. Following the Start condition, the 8 bits are shifted into the SSPSR register. All incoming bits are sampled with the rising edge of the clock (SCL) line. The value of register SSPSR<7:1> is compared to the value of the SSPADD register. The address is compared on the falling edge of the eighth clock (SCL) pulse. If the addresses match and the BF and SSPOV bits are clear, the following events occur:

- 1. The SSPSR register value is loaded into the SSPBUF register.
- 2. The Buffer Full bit, BF, is set.
- 3. An ACK pulse is generated.
- 4. MSSP Interrupt Flag bit, SSPIF (PIR1<3>), is set (interrupt is generated, if enabled) on the falling edge of the ninth SCL pulse.

In 10-Bit Addressing mode, two address bytes need to be received by the slave. The five Most Significant bits (MSbs) of the first address byte specify if this is a 10-bit address. Bit R/W (SSPSTAT<2>) must specify a write so the slave device will receive the second address byte. For a 10-bit address, the first byte would equal '11110 A9 A8 0', where 'A9' and 'A8' are the two MSbs of the address. The sequence of events for 10-bit address is as follows, with steps 7 through 9 for the slave-transmitter:

- 1. Receive first (high) byte of address (bits SSPIF, BF and UA (SSPSTAT<1>) are set).
- 2. Update the SSPADD register with second (low) byte of address (clears bit UA and releases the SCL line).
- 3. Read the SSPBUF register (clears bit BF) and clear flag bit, SSPIF.
- 4. Receive second (low) byte of address (bits SSPIF, BF and UA are set).
- 5. Update the SSPADD register with the first (high) byte of address. If match releases SCL line, this will clear bit UA.
- 6. Read the SSPBUF register (clears bit BF) and clear flag bit, SSPIF.
- 7. Receive Repeated Start condition.
- 8. Receive first (high) byte of address (bits SSPIF and BF are set).
- 9. Read the SSPBUF register (clears bit BF) and clear flag bit, SSPIF.



18.4.6.1 I²C Master Mode Operation

The master device generates all of the serial clock pulses and the Start and Stop conditions. A transfer is ended with a Stop condition or with a Repeated Start condition. Since the Repeated Start condition is also the beginning of the next serial transfer, the I²C bus will not be released.

In Master Transmitter mode, serial data is output through SDA, while SCL outputs the serial clock. The first byte transmitted contains the slave address of the receiving device (7 bits) and the Read/Write (R/W) bit. In this case, the R/W bit will be logic '0'. Serial data is transmitted 8 bits at a time. After each byte is transmitted, an Acknowledge bit is received. Start and Stop conditions are output to indicate the beginning and the end of a serial transfer.

In Master Receive mode, the first byte transmitted contains the slave address of the transmitting device (7 bits) and the R/\overline{W} bit. In this case, the R/\overline{W} bit will be logic '1'. Thus, the first byte transmitted is a 7-bit slave address followed by a '1' to indicate the receive bit. Serial data is received via SDA, while SCL outputs the serial clock. Serial data is received 8 bits at a time. After each byte is received, an Acknowledge bit is transmitted. Start and Stop conditions indicate the beginning and end of transmission.

The Baud Rate Generator used for the SPI mode operation is used to set the SCL clock frequency for either 100 kHz, 400 kHz or 1 MHz I²C operation. See **Section 18.4.7 "Baud Rate"** for more detail.

A typical transmit sequence would go as follows:

- 1. The user generates a Start condition by setting the Start Enable bit, SEN (SSPCON2<0>).
- 2. SSPIF is set. The MSSP module will wait the required start time before any other operation takes place.
- 3. The user loads the SSPBUF with the slave address to transmit.
- 4. Address is shifted out the SDA pin until all 8 bits are transmitted.
- 5. The MSSP module shifts in the ACK bit from the slave device and writes its value into the SSPCON2 register.
- The MSSP module generates an interrupt at the end of the ninth clock cycle by setting the SSPIF bit.
- 7. The user loads the SSPBUF with eight bits of data.
- 8. Data is shifted out the SDA pin until all 8 bits are transmitted.
- 9. The MSSP module shifts in the ACK bit from the slave device and writes its value into the SSPCON2 register.
- 10. The MSSP module generates an interrupt at the end of the ninth clock cycle by setting the SSPIF bit.
- 11. The user generates a Stop condition by setting the Stop Enable bit, PEN (SSPCON2<2>).
- 12. Interrupt is generated once the Stop condition is complete.

REGISTER 20-3:	ADCON2:	A/D CONT	ROL REG	ISTER 2				
	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	ADFM		ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0
	bit 7							bit 0
bit 7	ADFM: A/D	Result For	mat Select b	bit				
	1 = Right ju 0 = Left jus							
bit 6	Unimplem	ented: Read	d as '0'					
bit 5-3	ACQT<2:0	>: A/D Acqu	isition Time	Select bits				
	$111 = 20 \text{ TAD}$ $110 = 16 \text{ TAD}$ $101 = 12 \text{ TAD}$ $100 = 8 \text{ TAD}$ $011 = 6 \text{ TAD}$ $010 = 4 \text{ TAD}$ $001 = 2 \text{ TAD}$ $000 = 0 \text{ TAD}^{(1)}$							
bit 2-0	ADCS<2:0>: A/D Conversion Clock Select bits 111 = FRC (clock derived from A/D RC oscillator) ⁽¹⁾ 110 = Fosc/64 101 = Fosc/16 100 = Fosc/4 011 = FRC (clock derived from A/D RC oscillator) ⁽¹⁾ 010 = Fosc/32 001 = Fosc/8 000 = Fosc/2 Note 1: If the A/D FRC clock source is selected, a delay of one Tcy (instruction cycle) is added before the A/D clock starts. This allows the SLEEP instruction to be executed							
			ting a conve					

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented b	oit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

NOTES:

GOT	ю	Uncondit	ional Brar	ch		INCF		Incremer	nt f		
Synta	Syntax: GOTO k		Synta	x:	INCF f{,	INCF f {,d {,a}}					
Oper	ands:	$0 \le k \le 104$	8575			Opera	inds:	$0 \le f \le 255$	$0 \le f \le 255$		
Operation: $k \rightarrow PC<20:1>$				$d \in [0, 1]$							
Status Affected: None		Opor	tion:		$\mathbf{a} \in [0, 1]$						
Encoding: 1st word (k<7:0>)		1110 1111 k ₇ kkk		kkkk ₀	Operation: Status Affected:		(f) + 1 → dest C, DC, N, OV, Z				
2nd ۱	word(k<19:8>)	1111	k ₁₉ kkk k	kkk	kkkk ₈	Encod	ling:	0010	10da	ffff	ffff
Description: GOTO allows an uncondition anywhere within entire 2-Mbyte memory range. The value 'k' is loaded into PC<2 GOTO is always a two-cycle instruction.		. The PC<20	20-bit	Descr	iption:	The conter incremente placed in V placed bac If 'a' is '0', If 'a' is '1',	ed. If 'd' is V. If 'd' is k in regis the Acces the BSR i	6 '0', the r '1', the re ter 'f' (de ss Bank is s used to	esult is esult is fault). s selected.		
Word	ls:	2						GPR bank If 'a' is '0' a	· ,		nstruction
Cycle	es:	2						set is enab	oled, this i	nstructio	n operates
QC	ycle Activity:							in Indexed mode whe			
	Q1	Q2	Q3		Q4			Section 2		· · ·	
	Decode	Read literal 'k'<7:0>,	No operation	ʻk	ead literal c'<19:8>, rite to PC			Bit-Orient Literal Off			
	No	No	No	vv	No	Words	8:	1			
	operation	operation	operation	0	peration	Cycle	s:	1			
						Q Cy	cle Activity:				
<u>Exan</u>	nple:	GOTO THE	RE			-	Q1	Q2	Q3		Q4
	After Instructio PC =	n Address (T	HERE)				Decode	Read register 'f'	Proce Data		Write to estination
						<u>Exam</u> E	<u>ple:</u> Before Instruc CNT Z C	INCF etion = FFh = 0 = ?	CNT,	1, 0	
							DC After Instructi	= ?			

After Instruction

=

= = = 1 1 1

00h

CNT Z C DC

RETURN Return from Subroutine								
Syntax: RETURN {s}								
Oper	ands:	S ∈ [0,1]						
$\begin{array}{llllllllllllllllllllllllllllllllllll$					nged			
Statu	s Affected:	None						
Enco	ding:	0000	0000	0001	001s			
Desc	ription:	popped and is loaded in 's'= 1, the c registers, W are loaded i registers, W 's' = 0, no u	Return from subroutine. The stack is popped and the top of the stack (TOS) is loaded into the program counter. If 's'= 1, the contents of the shadow registers, WS, STATUSS and BSRS, are loaded into their corresponding registers, W, STATUS and BSR. If 's' = 0, no update of these registers occurs (default).					
Word	ls:	1	1					
Cycle	es:	2						
QC	ycle Activity:							
	Q1	Q2	Q	3	Q4			
	Decode	No	Proce		POP PC			
		operation	Dat	a fro	om stack			
	No	No	No		No			
	operation	operation	opera	tion o	peration			
Exan	nple:	RETURN						

Examp	ole:

After Instruction: PC = TOS

RLCF	Rotate Lo	eft f thro	ugh Ca	arry			
Syntax:	RLCF f	{,d {,a}}					
Operands:	0≤f≤255 d∈[0,1] a∈[0,1]						
Operation:	$(f \le n >) \rightarrow d$ $(f \le 7 >) \rightarrow C$ $(C) \rightarrow desi$	Э,	>,				
Status Affected:	C, N, Z						
Encoding:	0011	01da	ffff	ffff			
	one bit to the left through the Carry flag. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.						
		details.					
Words:	Mode" for	details.	xed Lite				
Words:	Mode" for	details.	xed Lite				
Cycles:	Mode" for	details.	xed Lite				
Cycles: Q Cycle Activity:	Mode" for <u>C</u> 1 1	details.]← re	xed Lite	eral Offset			
Cycles:	Mode" for	details.	egister f				
Cycles: Q Cycle Activity: Q1	Mode" for C 1 1 Q2 Read	Q3 Proce Data	egister f	Q4 Write to			
Cycles: Q Cycle Activity: Q1 Decode	Mode" for C 1 1 2 C 1 1 2 C Read register 'f' RLCF tion = 1110 (= 0	Q3 Proce Data REG,	ss d a d	Q4 Write to			

RRNCF	ight f (No C	Carry)				
Syntax:	RRNCF f {,d {,a}}					
Operands:	$0 \le f \le 255$ $d \in [0, 1]$ $a \in [0, 1]$					
Operation:	$(f < n >) \rightarrow c$ $(f < 0 >) \rightarrow c$	lest <n 1="" –="">, lest<7></n>				
Status Affected:	N, Z					
Encoding:	0100	00da f	fff ffff			
Description:	The contents of register 'f' are rotated one bit to the right. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default). If 'a' is '0', the Access Bank will be selected, overriding the BSR value. If ' is '1', then the bank will be selected at per the BSR value (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operate in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.					
		 regist 	ter f			
Words:		regist	ter f			
Words: Cvcles:	1 1	► regist	ter f			
Cycles:	-	► regist	ler f			
	-	► regist	ter f			
Cycles: Q Cycle Activity:	1					
Cycles: Q Cycle Activity: Q1	1 Q2 Read	Q3 Process	Q4 Write to			
Cycles: Q Cycle Activity: Q1 Decode	1 Q2 Read register 'f' RRNCF tion = 1101	Q3 Process Data REG, 1, 0 0111	Q4 Write to			
Cycles: Q Cycle Activity: Q1 Decode Example 1: Before Instruct REG After Instruction REG	1 Q2 Read register 'f' RRNCF tion = 1101 on = 1110	Q3 Process Data REG, 1, 0 0111 1011	Q4 Write to			
Cycles: Q Cycle Activity: Q1 Decode Example 1: Before Instructor REG After Instruction REG Example 2:	1 Q2 Read register 'f' RRNCF tion = 1101 on = 1110 RRNCF	Q3 Process Data REG, 1, 0 0111 1011	Q4 Write to			
Cycles: Q Cycle Activity: Q1 Decode Example 1: Before Instruct REG After Instruction REG	1 Q2 Read register 'f' RRNCF tion = 1101 m = 1110 RRNCF tion = ? = 1101	Q3 Process Data REG, 1, 0 0111 1011 REG, 0, 0	Q4 Write to			

SETF	Set f						
Syntax:	SETF f{,	a}					
Operands:	0 ≤ f ≤ 255 a ∈ [0,1]						
Operation:	$FFh\tof$	$FFh \to f$					
Status Affected:	None	None					
Encoding:	0110	100a :	ffff	ffff			
Description:	are set to F If 'a' is '0', t If 'a' is '1', t GPR bank If 'a' is '0' a set is enab in Indexed mode wher Section 25 Bit-Oriente	The contents of the specified register are set to FFh. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.					
Words:	1						
Cycles:	1						
Q Cycle Activity:							
Q1	Q2	Q3		Q4			
Decode	Read register 'f'	Process Data		Write gister 'f'			
Example: Before Instruc REG	SETF tion = 5A	REG,	1				

REG	=	5Ah
After Instruction		
REG	=	FFh

SUBLW	5	Subtract	W from	n Lite	ral	
Syntax:	9	SUBLW	k			
Operands:	C	$0 \le k \le 25$	5			
Operation:	k	$i - (W) \rightarrow$	W			
Status Affected:	١	I, OV, C,	DC, Z			
Encoding:	Γ	0000	1000	kkk	k	kkkk
Description			acted from			
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1		Q2	Q3			Q4
Decode		Read eral 'k'	Proce Data		W	rite to W
Example 1:	S	UBLW ()2h			
Before Instru W C After Instruc W C Z N	=	01h ? 01h 1 ;r 0	esult is p	ositive	9	
Example 2:	S	UBLW ()2h			
Before Instru W C After Instruc W	=	02h ? 00h				
C Z N	= = =	1;r 1 0	esult is z	ero		
Example 3:	S	SUBLW ()2h			
Before Instru W C After Instruc W C Z N	=		(2's comp result is r			

SUBWF		5	Subtra	ct	W from f		
Syntax:		S	SUBWF		f {,d {,a}}		
Operands:			$0 \le f \le 255$ $d \in [0, 1]$ $a \in [0, 1]$				
Operation:			f) – (W)	-	→ dest		
Status Affected:			1, OV, C	C, I	DC, Z		
Encoding:			0101		11da fff	f ffff	
Description:			Subtract W from register 'f' (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:		1					
Cycles:		1					
Q Cycle A	ctivity:						
	Q1		Q2		Q3	Q4	
De	code		Read gister 'f'	1	Process Data	Write to destination	
Example 1	<u>:</u>	S	UBWF		REG, 1, 0		
F	e Instruc REG V C	tion = = =	3 2 ?				
F	2	n = = = =	1 2 1 0	;।	result is positiv	/e	
Example 2	<u>.</u>	S	SUBWF		REG, 0, 0		
F V C	e Instruc REG V C	= = =	2 2 ?				
F	REG W Z	" = = = =	2 0 1 1 0	;।	result is zero		
Example 3	•	S	SUBWF		REG, 1, 0		
F	e Instruc REG V C	tion = = =	1 2 ?				
F	2	n = = = =	FFh 2 0 0 1		2's complemer result is negati		
ľ	•	-	1				

28.0 PACKAGING INFORMATION

28.1 Package Marking Information

28-Lead SPDIP



28-Lead SOIC



28-Lead QFN



28-Lead SSOP





Example



Example



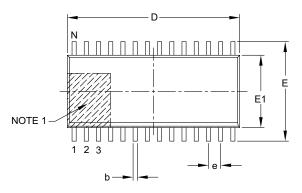
Example

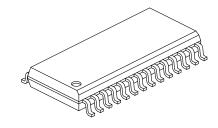


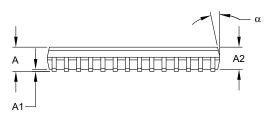
Leg	end:	XXX Y YY WW NNN @3 *	Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.				
Not	b	In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.					

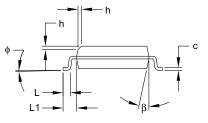
28-Lead Plastic Small Outline (SO) – Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging









	Units		MILLIMETERS		
C	Dimension Limits	MIN	NOM	MAX	
Number of Pins	N		28		
Pitch	е		1.27 BSC		
Overall Height	А	-	-	2.65	
Molded Package Thickness	A2	2.05	—	-	
Standoff §	A1	0.10	—	0.30	
Overall Width	E	10.30 BSC			
Molded Package Width	E1	7.50 BSC			
Overall Length	D	17.90 BSC			
Chamfer (optional)	h	0.25	_	0.75	
Foot Length	L	0.40	_	1.27	
Footprint	L1		1.40 REF		
Foot Angle Top	ф	0°	_	8°	
Lead Thickness	С	0.18	—	0.33	
Lead Width	b	0.31	_	0.51	
Mold Draft Angle Top	α	5°	_	15°	
Mold Draft Angle Bottom	β	5°	-	15°	

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. § Significant Characteristic.

3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.

4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-052B